## BEUSSE BROWNLEE WOLTER MORA & MAIRE, P.A.

FACSIMILE TRANSMITTAL SHEET	
TO	12084
	James H. Beusse
Art Unit: 2826	-
Examiner: Fazli Erdem	
COMPANY	DA'IE
U.S. Parent Office	February 24, 2005
703-872-9306 – Central Fa	x No. 7
1-866-217-9197	SENDER'S REFERENCE NUMBER: 075903-033
<sup>Ke-</sup> 09/967 <b>,</b> 094	уоих керекемсь мимьяк
☐ URGENT ☐ FOR REVIEW	□ PLEASE COMMENT □ PLEASE REPCY □ PLEASE RECYCLE
NOTES/COMMEN'S	

RESPONSE TO OFFICE ACTION OF JANUARY 4, 2005.

Please confirm receipt.

THANKS.

Application No. 09/967,094

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

First Named Inventor:

Siddhartha Bhowmik

**Application No.:** 

09/967,094

Filed:

09/28/2001

Examiner: Fazli Erdem

Art Unit:

2826

For: Barrier Layer For Interconnect Structures Of A Semiconductor Wafer and Method For

Depositing The Barrier Layer

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

## RESPONSE AFTER FINAL REJECTION <u>UNDER 37 CFR 1.116</u>

This paper is in response to the Final Rejection contained in the official Office Communication dated 01/04/2005, having a response due date of April 4, 2005.

Entry of this amendment is respectfully requested to place the application in condition for allowance, or in the alternative, to place the claims in better condition for consideration on appeal.

Please proceed to the following page.